

# **L.T.F** Q-LUX DC LED Boards

### Ultra High Light Output QLUXR7615W48LED Series



#### FEATURES

- High Color Renedering Index (CRI) Ra max. 98
- High efficacy lumen output
- LM-80 compliant LEDs
- Tight Binning 3 Step Mac Adam Ellipses
- Uniform & Crisp Light Source Intensity
- Hot Spot Free Design
- Exceed ENERGY STAR lumen maintenance requirements
- Extra thin low profile
- Low heat generation, easy thermal management
- Easy to fit in new design or retrofit applications

# Information OverviewWattage22WAvailable CRI80/90+ \*Available CCT2200-5000KDimensions76mm (OD)Number of LEDs16Beam Angle120



#### **APPLICATIONS**

For Architectural New Designs and Retrofits lighting fixtures:

Indoor Lightings:

- Recessed can light
- Ceiling light
- Wall sconces
- Table lamps
- Fixtures
- Signage

#### Outdoor Lightings:

- Street light
- Marker lights
- Wall sconces
- Signage lights

## ELECTRICAL SPECS.

22W Round	Wattage	Forward Voltage			Forward Curren	
Model Number	Max.	Тур.	Vf Min.	Vf Max.	Тур.	Max.
QLUXR7615W48LED	22W	36V	33V	40V	420mA	600mA

Order Number	CRI	ССТ
QLUXR7615W48LED22K8CR	80+	2200K
QLUXR7615W48LED25K8CR	80+	2500K
QLUXR7615W48LED27K8CR	80+	2700K
QLUXR7615W48LED30K8CR	80+	3000K
QLUXR7615W48LED32K8CR	80+	3200K
QLUXR7615W48LED35K8CR	80+	3500K
QLUXR7615W48LED40K8CR	80+	4000K
QLUXR7615W48LED50K8CR	80+	5000K

Order Number	CRI	ССТ
QLUXR7615W48LED22K9CR	90+	2200K
QLUXR7615W48LED25K9CR	90+	2500K
QLUXR7615W48LED27K9CR	90+	2700K
QLUXR7615W48LED30K9CR	90+	3000K
QLUXR7615W48LED32K9CR	90+	3200K
QLUXR7615W48LED35K9CR	90+	3500K
QLUXR7615W48LED40K9CR	90+	4000K
QLUXR7615W48LED50K9CR	90+	5000K

\* Up to 98 CRI



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#### **ELECTRICAL SPECIFICATIONS - 80 CRI**

#### Absolute Maximum Ratings (Ta=25C, RH30%)

Parameter	Symbol	Rating	Unit
DC Input Forward Current *	I <sub>IN</sub>	600	mA
Power Dissipation	P <sub>D</sub>	22	W
Junction Temperature*	Tj	125	°C
<b>Operating Temperature</b>	Topr	-20 ~ +50	°C
ESD	HBM	5000	V
Storage Temperature	Tstg	-40 ~ +80	°C
Temperature of AI MCPCB** Max.	TS	85	°C

Parameter	Symbol	Condition	Model	Min.	Тур.	Max.	Unit
Forward Voltage*	VF	I <sub>F</sub> = 420 mA		33	36	40	V
			2700K		1890		
			3000K		1966		
Total Flux	ΦV	I <sub>F</sub> = 420 mA	3500K		2041		Im
			4000K		2117		
			5000K		2268		
<b>Efficacy</b> ղ	η l <sub>r</sub> =		2700K		125		Im/W
			3000K		130		
		η I <sub>F</sub> = 420 mA	3500K		135		
			4000K		140		
			5000K		150		
			2700K		2700		
			3000K		3000		
Color Temperature	ССТ	I <sub>F</sub> = 420 mA	3500K		3500		
			4000K		4000		
		5000K		5000			
Color Rendering Index**	CRI	I <sub>F</sub> = 420 mA		80			
Viewing Angle***	20 <sub>1/2</sub>	I <sub>F</sub> = 420 mA			120		degre
Life Time (L <sub>70</sub> )	т	65C at T <sub>s</sub>			50000		hours

\* Notes: All measurements were made under the standardized environment of SSC.

\*\* CCT is <90 for +4000K boards

\*\*\*  $2\theta 1/2$  is the off-axis where the luminous intensity is 1/2 of the peak intensity.

\*\*\*\* Thermal resistance: RthJS (junction / solder)

Tolerance: VF :±0.1V, IV :±7%, Ra :±2, x,y :±0.007



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#### **ELECTRICAL SPECIFICATIONS - 90 CRI**

#### Absolute Maximum Ratings (Ta=25C, RH30%)

Parameter	Symbol	Rating	Unit
DC Input Forward Current *	I <sub>IN</sub>	600	mA
Power Dissipation	P <sub>D</sub>	22	W
Junction Temperature*	Tj	125	°C
Operating Temperature	Topr	-20 ~ +50	°C
ESD	HBM	5000	V
Storage Temperature	Tstg	-40 ~ +80	°C
Temperature of AI MCPCB** Max.	TS	85	°C

lectrical & Optical Characte	eristics (Ta=25	C, RH30%)					
Parameter	Symbol	Condition	Model	Min.	Тур.	Max.	Unit
Forward Voltage*	VF	I <sub>F</sub> = 420 mA		33	36	40	V
			2700K		1650		
			3000K		1800		
Total Flux	ΦV	I <sub>F</sub> = 420 mA	3500K		1875		lm
			4000K		1950		
			5000K		2175		
	<b>Efficacy</b> ղ I <sub>F</sub> = 420 m/		2700K		110		Im/W
		I <sub>F</sub> = 420 mA	3000K		120		
Efficacy			3500K		125		
			4000K		130		
			5000K		145		
			2700K		2700		
			3000K		3000		
Color Temperature	ССТ	I <sub>F</sub> = 420 mA	3500K		3500		
			4000K		4000		
		5000K		5000			
Color Rendering Index**	CRI	I <sub>F</sub> = 420 mA		90		98	
Viewing Angle***	20 <sub>1/2</sub>	I <sub>F</sub> = 420 mA			120		degre
Life Time (L <sub>70</sub> )	Т	65C at T <sub>s</sub>			50000		hour

\* Notes: All measurements were made under the standardized environment of SSC.

\*\* CCT is <90 for +4000K boards

\*\*\* 201/2 is the off-axis where the luminous intensity is 1/2 of the peak intensity.

\*\*\*\* Thermal resistance: RthJS (junction / solder)

Tolerance: VF :±0.1V, IV :±7%, Ra :±2, x,y :±0.007

LTF y CIE1931 Chromaticity Diagram 1.0 Spectral Ratio: R=47.4%,G=41.9%,B=10.7%, . 8 . 6 0.5 4 . 2 460 620 700 780 0 0.1 0.3 0.5 0.7 380 540 х

Recommended LED Drivers						
120V 277V 200-240V Universal						
DA25W420C	DE25W420C	DU25W420C	DS25W420C			

#### MECHANICAL SPECS.



#### • Turn the power off before installing LED to the proper constant current LED driver. • Avoid short circuit, or drilling / cutting the LED board! It will damage its electrical circuit!

CAUTION!





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## Precaution for use:

#### (1) Storage

To avoid the moisture penetration, we recommend store in a dry box

with a desiccant . The recommended storage temperature range is 5C to 30C and a maximum humidity of RH50%.

(2) Use Precaution after Opening the Packaging as separation of the lens may affect the light output efficiency.

Pay attention to the following:

a. Recommend conditions after opening the package

- Sealing

- Temperature : 5 ~ 40°C Humidity : less than RH30%

b. If the package has been opened more than 4 week(MSL\_2a) or the color of the

desiccant changes, components should be dried for 10-12hr at  $60\pm5^\circ\text{C}$ 

(3) Do not apply mechanical force or excess vibration during the cooling process to normal

temperature after soldering.

(4) Do not rapidly cool device after soldering.

(5) Components should not be mounted on warped (non coplanar) portion of PCB.

(6) Radioactive exposure is not considered for the products listed here in.(7) Gallium arsenide is used in some of the products listed in this publication. These products are dangerous if they are burned or shredded in the process of disposal. It is also dangerous to

drink the liquid or inhale the gas generated by such products when chemically disposed of.

(8) This device should not be used in any type of fluid such as water, oil, organic solvent and etc. When washing is required, IPA (Isopropyl Alcohol) should be used.

(9) When the LEDs are in operation the maximum current should be decided after measuring the package temperature.

(10) LEDs must be stored properly to maintain the device. If the LEDs are stored for 3 months or more after being shipped from SSC, a sealed container with a nitrogen atmosphere should be used for storage.

(11) The appearance and specifications of the product may be modified for improvement without notice.

(12) Long time exposure of sunlight or occasional UV exposure will cause lens discoloration.

(13) VOCs (Volatile organic compounds) emitted from materials used in the construction of fixtures can penetrate silicone encapsulants of LEDs and discolor when exposed to heat and photonic energy. The result can be a significant loss of light output from the fixture.

Knowledge of the properties of the materials selected to be used in the construction of fixtures can help prevent these issues.

(14) Attaching LEDs, do not use adhesives that outgas organic vapor.

(15)The driving circuit must be designed to allow forward voltage only when it is ON or OFF.

If the reverse voltage is applied to LED, migration can be generated resulting in LED damage.